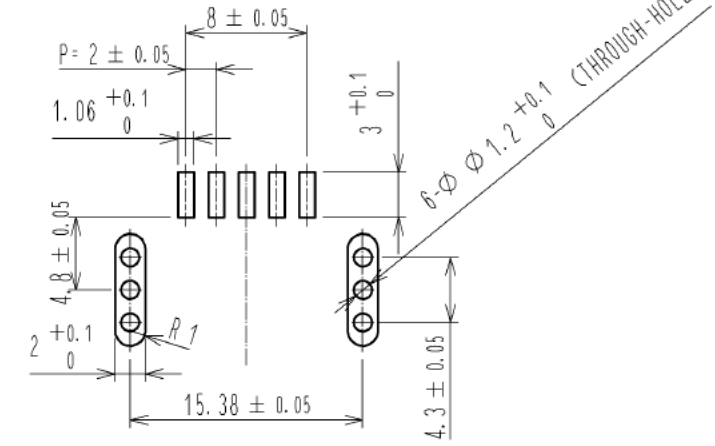
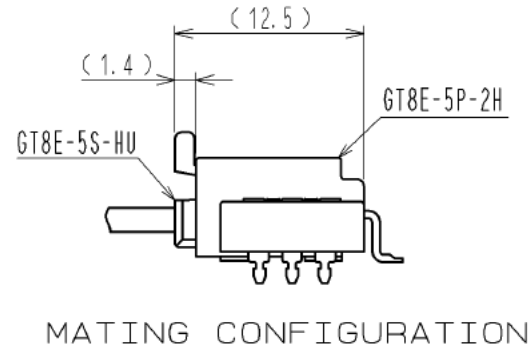
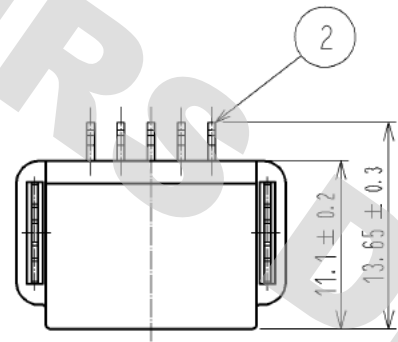
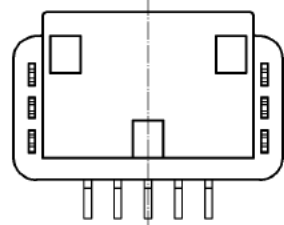
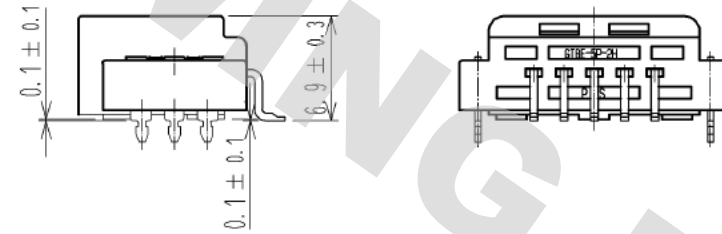
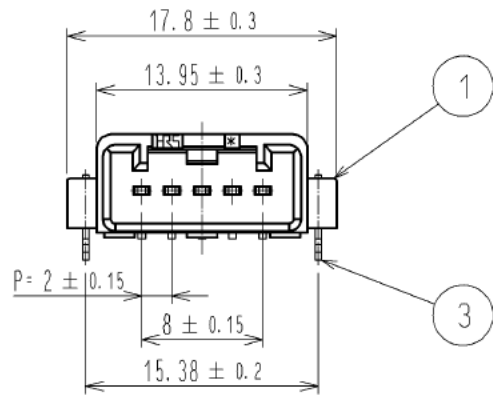


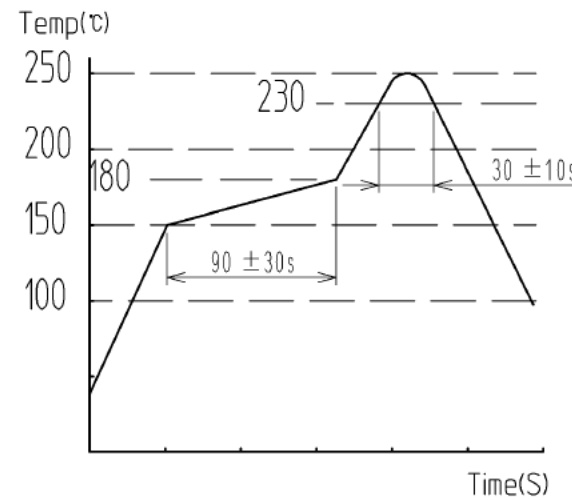
ELV. RoHS COMPLIANT



RECOMMENDED PC BOARD PATTERN



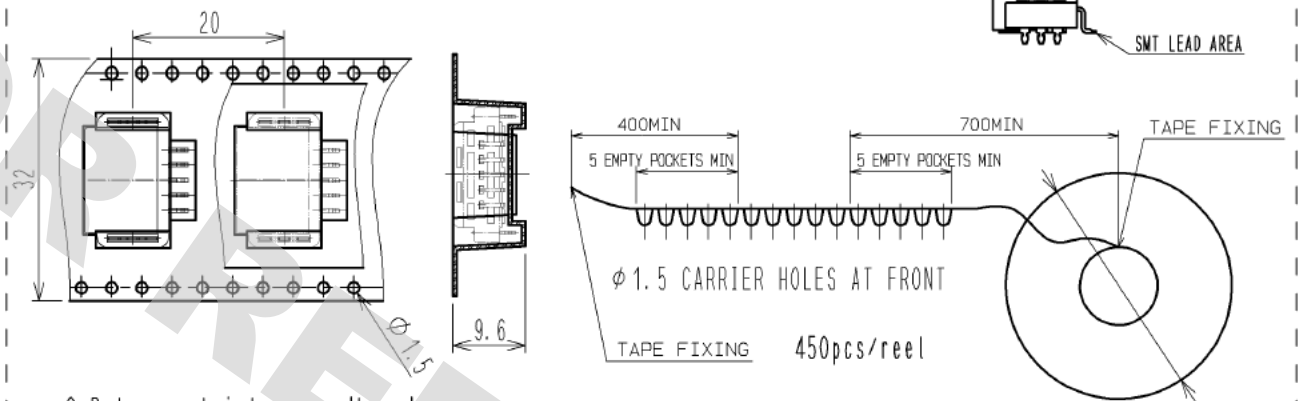
- NOTE 1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW
(REFER TO RIGHT FIG.)
USED REFLOW SYSTEM
: IR IN THE AIR OR NITROGEN
NO. OF CYCLES : 2 MAX
PEAK : 250°C
OVER 230°C : 20~40s
PREHEAT : 150~180°C
60~120s
2. TEMPERATURE FOR SOLDERING IRON
: 280~300°C WITHIN 2s
3. CO-PLANARITY SHALL BE 0.1 MAX.
4. MARKING OF Lot No. :
(EX)2009.6TH. SEPTEMBER → 09I06---5DIGITS
5. PC BOARD THICKNESS=1.6.
6. RECOMMENDED SOLDER THICKNESS=0.15
7. 1 REEL IS 450 CONECTORS.



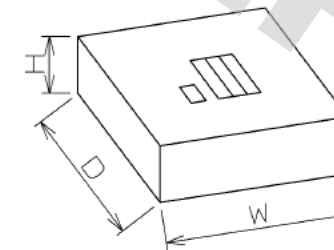
PACKING STYLE

1. Place connectors into an embossed carrier tape.

← DIRECTION OF UNREELING



2. Put a reel into a cardboard.



W = (405) (mm)
D = (405) (mm)
H = (39) (mm)

2	BRASS	TIN-COPPER ALLOY PLATING	3	BRASS	TIN-COPPER ALLOY PLATING
1	PPS	BLACK			
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 	DESCRIPTION OF REVISIONS	DESIGNED CHECKED DATE
HRS HIROSE ELECTRIC CO., LTD.		APPROVED : AR. SHIRAI 12.06.26	DRAWING NO. EDC3-167880-00		
		CHECKED : AR. SHIRAI 12.06.26	PART NO. GT8E-5P-2H		
		DESIGNED : NA. HARUBAYASHI 12.06.26	CODE NO. CL758-1004-1-00		
		DRAWN : KT. OKABE 12.06.25			

DRAWING FOR REFERENCE: This is subject to change without notice
05/31/2013